

File No. DK-US055289

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of	:	
	:	
Shin KURITA et al.	:	Patent Art Unit: 3748
	:	
Serial No.: 10/559,935	:	
	:	
Filed: December 8, 2005	:	
	:	
For: ROTARY FLUID MACHINE	:	

**INFORMATION DISCLOSURE STATEMENT**

Assistant Commissioner of Patents  
Washington, DC 20231

Sir:

In accordance with MPEP 609 and 37 C.F.R. §§ 1.56, 1.97 and 1.98, Applicants bring the attached references to the Examiner's attention and request that they be considered and made of record in this application. Also attached is a completed PTO-1449 form.

*No fee is believed to be due for this Information Disclosure Statement.* However, if a first Office Action on the merits was mailed before the filing date of this Information Disclosure Statement, the Commissioner is authorized to charge the fee set forth in 37 CFR § 1.17(p) to Deposit Account No. 50-1836. A duplicate copy of this Statement is enclosed for that purpose.


A copy of Office Action of the corresponding Chinese Patent Application No. 2004800160185 is attached hereto.

Chinese Patent Application Publication No. 1218143 appears to disclose a piston that is slidable in a groove of a rotary cylinder. An English abstract is provided for the Examiner's convenience.

\* \* \*

Prompt examination on the merits is respectfully requested.

Respectfully submitted,

  
David J. McCrosky  
Reg. No. 56,232

GLOBAL IP COUNSELORS, LLP  
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Dated: September 11, 2007

Substitute for form 1449A/PTO

**INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT**

(use as many sheets as necessary)

Sheet

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of

1

**Complete if Known**

Application Number	10/559,935
Filing Date	December 8, 2005
First Named Inventor	Shin KURITA
Group Art Unit	3748
Examiner Name	
Attorney Docket Number	DK-US055289

**U.S. PATENT DOCUMENTS**

Examiner Initials *	Cite No. <sup>1</sup>	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number - Kind Code <sup>2</sup> (if known)			
		US- 6,102,677	08-15-2000	IIDA et al.	
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**FOREIGN PATENT DOCUMENTS**

Examiner Initials *	Cite No. <sup>1</sup>	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T <sup>6</sup>
		Country Code <sup>3</sup> - Number <sup>4</sup> - Kind Code <sup>5</sup> (if known)				
		CN-1218143	06-02-1999	IIDA et al.		N

Examiner  
Signature

Date

Considered

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>1</sup> Applicant's unique citation designation number (optional). <sup>2</sup> See Kinds Codes of USPTO Patent Documents at [www.uspto.gov](http://www.uspto.gov) or MPEP 901.04.

<sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup> Applicant is to place a check mark here if English language Translation is attached.

Burden Hour Statement: This form is estimated to take 2.0 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Assistant Commissioner for Patents, Washington, DC 20231.